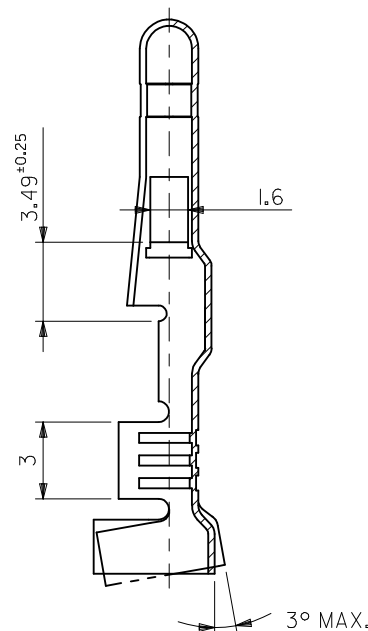
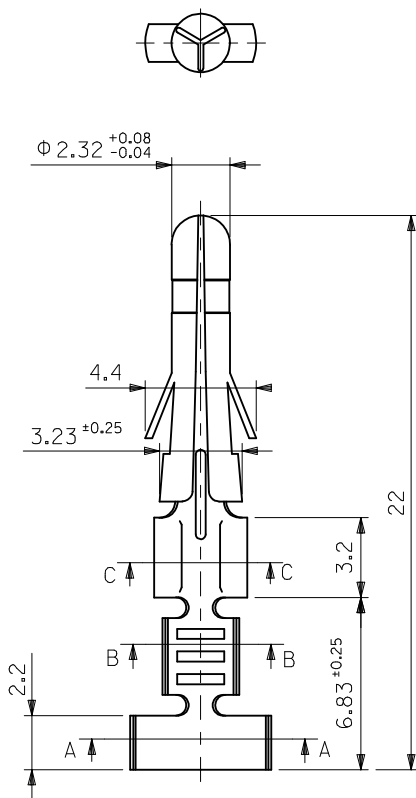
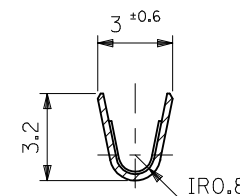
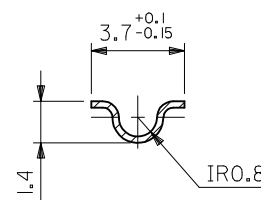


SECT. A-A



SECT. B-B



SECT. C-C

ニッケル (2 μm MIN.) 下地 金 (0.35 μm MIN.) OVER NICKEL (2 μm MIN.)	39-00-0300	1190G	連鎖状端子 CHAIN
銅 (0.5 μm MIN.) 下地 錫 (0.9 μm MIN.) OVER TIN (0.9 μm MIN.) OVER COPPER (0.5 μm MIN.)	39-00-0297	1190TL	バラ端子 LOOSE
メッキ PLATING	EDP.NO.	ENG.NO.	形状 FORM

REVISED EC NO: J2009-1285 DRWN: YOSHIDAM CHKD: THARUYAWA APPR: NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± ---	DRAWN BY H. HASEGAWA	DATE '93/06/18	TITLE .093 DIA. MALE TERM.				
		10 OVER 30 UNDER	± ---	CHECKED BY H. HIRAMOTO	DATE '93/06/18					
		30 OVER	± ---	APPROVED BY M. FUKUSHIMA	DATE '93/06/18	MOLEX INCORPORATED				
		ANGULAR	± --- °	MATERIAL NO.						
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-1190-001			1 OF 1		
	REV			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					